

Description

45V N-CHANNEL ENHANCEMENT MODE POWER MOSFET

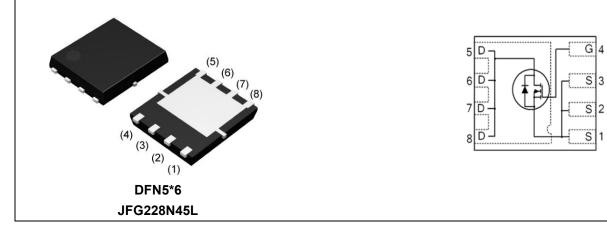
Features

- Device Rating V_{DS} = 45V, I_D = 228A
- $R_{DS(ON)} = 1.3m\Omega$ (typ.) @ V_{GS} = 10V, I_D = 20A
- R_{DS(ON)} =1.7mΩ (typ.) @ V_{GS} = 4.5V, I_D = 10A
- Proprietary High Density Trench Technology
- RoHS Compliant & Halogen-Free

Package

Application

- PD charger
- E-tool



Absolute Maximum Ratings Tc=25°C unless otherwise specified

Symbol	Parameter		Max.	Units
V _{DS}	Drain-Source Voltage		45	V
V _{GS}	Gate-Source Voltage		± 20	V
ID	Continuous Drain Current, VGS @ 10V ^{note1}	Tc = 25℃	228	А
		Tc = 100℃	145	А
I _{DM}	Pulsed Drain Current note2		912	А
PD	Power Dissipation note4	T _C = 25℃	131	W
	Power Dissipation	T _A = 25℃	2.27	W
Eas	Single Pulsed Avalanche Energy note3		383	mJ
Rejc	Thermal Resistance, Junction to Case note1		0.95	°C/W
RθJA	Junction-to-Ambient (mounted on 1 inch square PCB)		55	°C/W
Tj, Tstg	Operating and Storage Temperature Range		-55 to +150	°C



Electrical Characteristics Tc=25°C unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic	·				
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	45	-	-	V
IDSS	Drain-Source Leakage Current	V _{DS} = 45V, V _{GS} = 0V	-	-	1	μA
		V _{DS} = 45V, V _{GS} = 0V ,T _C = 55°C	-	-	10	μA
I _{GSS}	Gate-Source Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-100	-	100	nA
On Charac	cteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0	-	2.5	V
R _{DS(on)}	Static Drain-Source On-	V _{GS} = 10V, I _D =20A	-	1.3	1.6	mΩ
	Resistance ^{note2}	V _{GS} = 4.5V, I _D =20A	-	1.7	2.1	mΩ
g fs	Forward Transconductance	V _{DS} = 10V, I _D =20A		69	-	S
Dynamic C	Characteristics	1				
Rg	Gate Resistance		-	1.3	-	Ω
Ciss	Input Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$	-	7160	-	pF
Coss	Output Capacitance		-	1130	-	pF
C _{rss}	Reverse Transfer Capacitance	- f = 1.0MHz	-	1080	-	pF
Qg	Total Gate Charge	$V_{DS} = 20V, I_D = 20A,$	-	176	-	nC
Q _{gs}	Gate-Source Charge		-	17.8	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	- V _{GS} = 10V	-	58.4	-	nC
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	32	-	ns
tr	Turn-On Rise Time	V _{DD} = 20V, I _D = 20A,	-	96	_	ns
t _{d(off)}	Turn-Off Delay Time	R _G = 8Ω, V _{GS} = 10V	-	108	-	ns
t _f	Turn-Off Fall Time		-	68	-	ns
Drain-Sou	rce Diode Characteristics and Maxi	mum Ratings				
ls	Maximum Continuous Diode Forward Current note1,5		-	-	109	А
I _{SM}	Maximum Pulsed Diode Forward Current note2,5		-	-	912	А
t _{rr}	Reverse Recovery Time	T _J = 25°C, I _S = 20A,		65	-	ns
		V _{GS} = 0V	-			
Qrr	Reverse Recovery Charge	T _J = 25°C, I _S = 20A,		32		nC
		di/dt = 150A/µs				
V _{SD} ^{note2}	Drain to Source Diode Forward	T _J = 25°C, I _S = 20A,		0.72	-	V
	Voltage	$V_{GS} = 0V$	-			

Note :

1. The data tested by surface mounted on one inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.

3. The EAS data shows Max. rating. The test condition is VDD=40V, VGS=10V, L=0.1mH, IAS= 87.5 A.

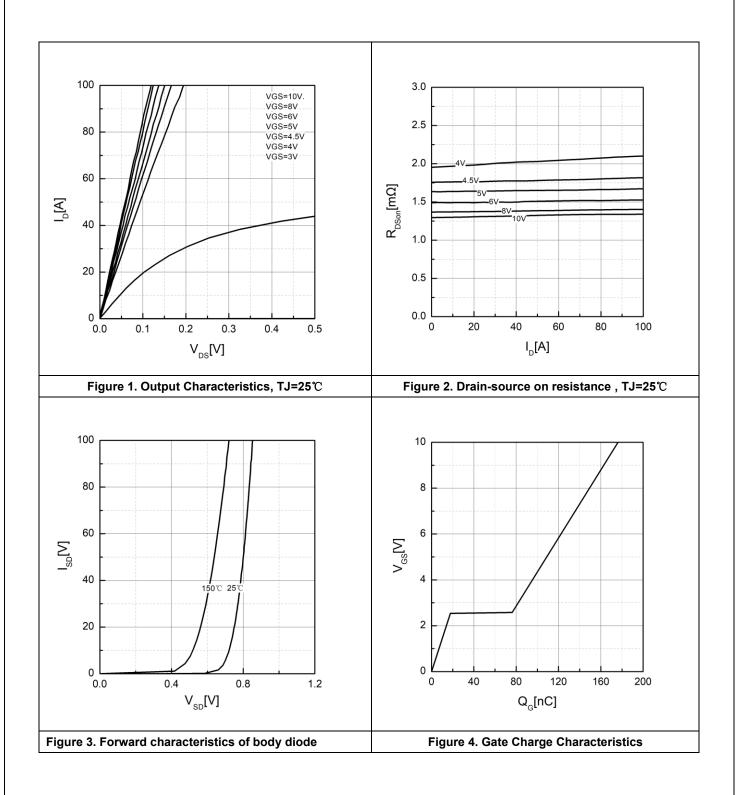
4. The power dissipation is limited by 150° C junction temperature.

5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

-2-

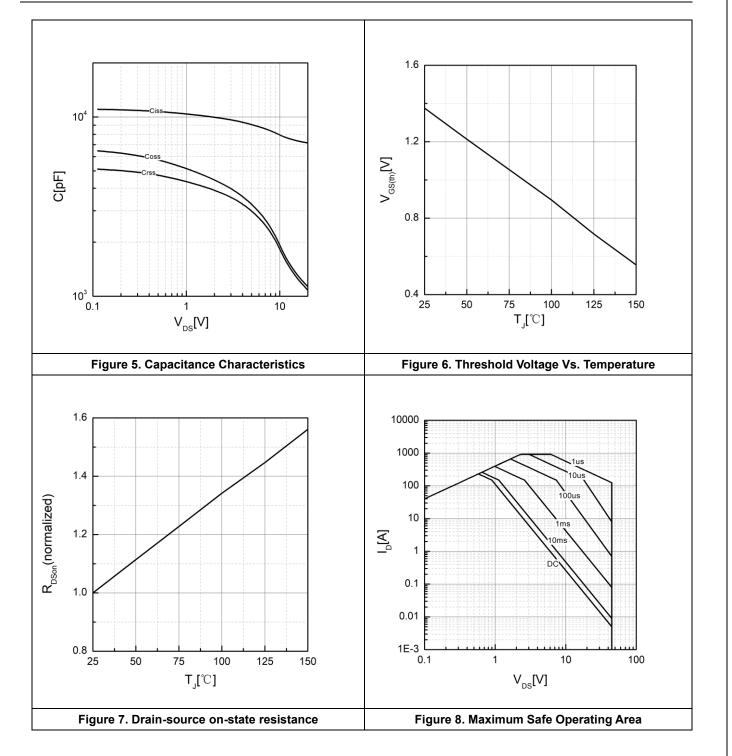


Typical Performance Characteristics



-3-

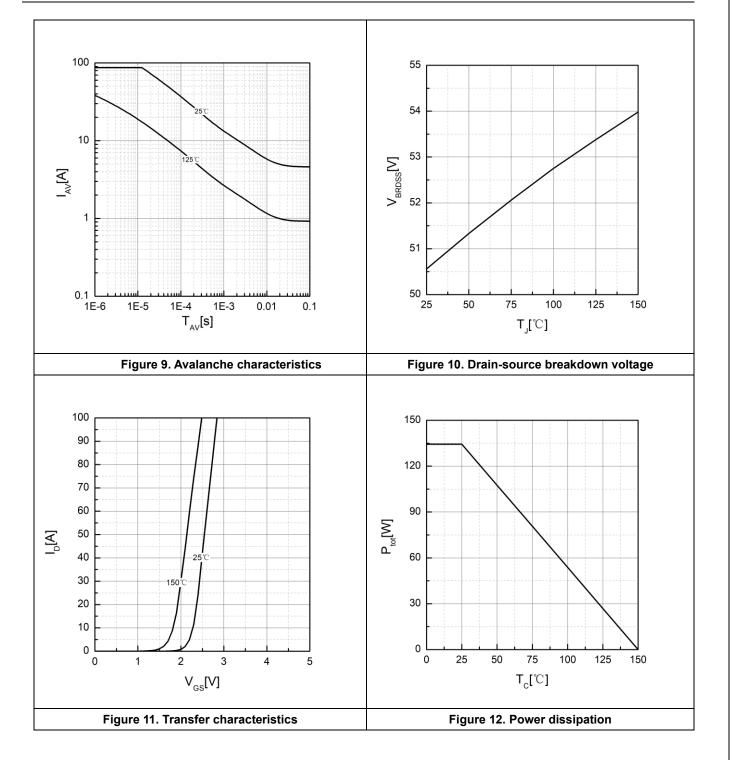




⁻⁴⁻

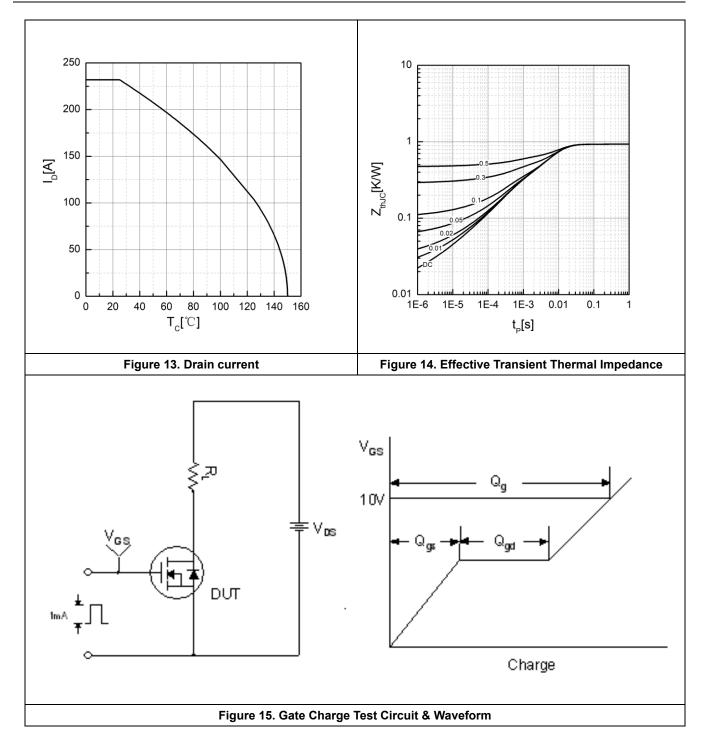


JFG228N45L

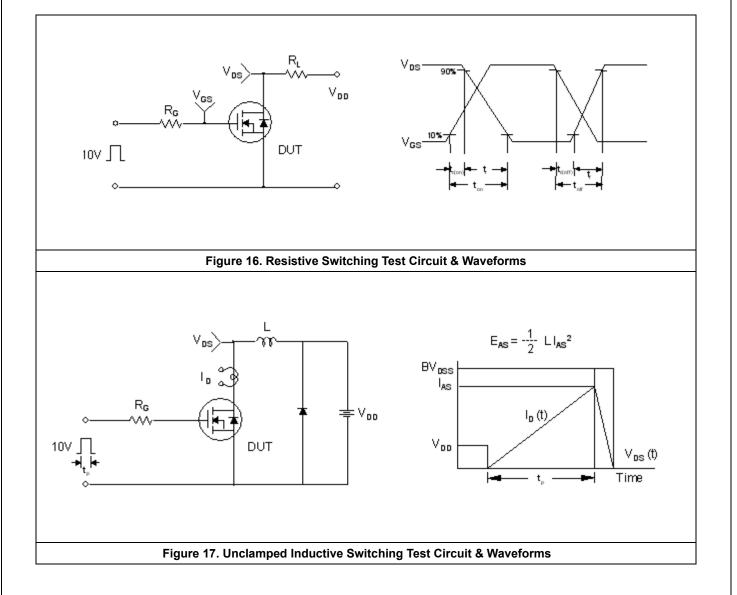


-5-



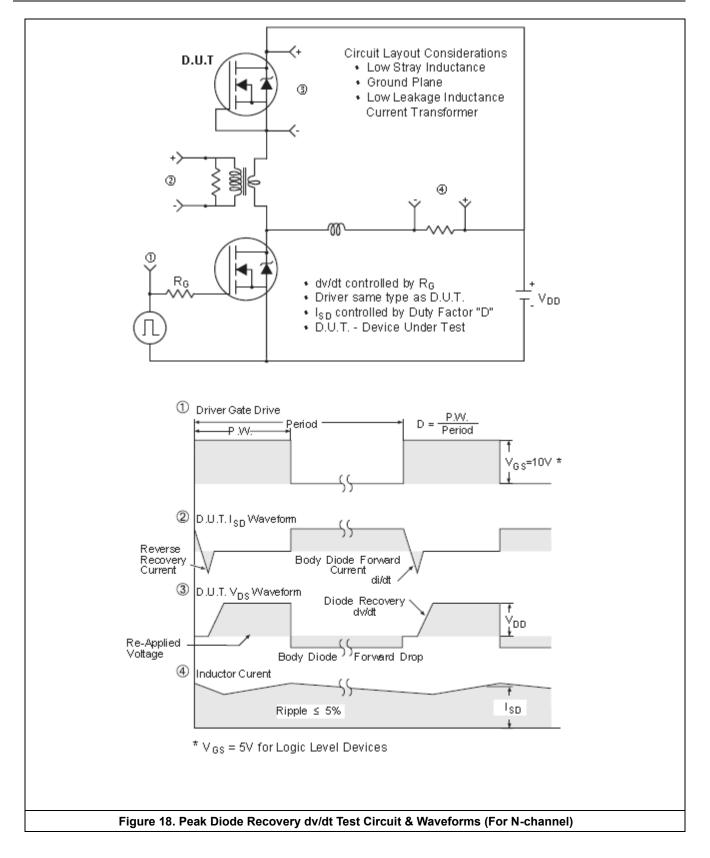






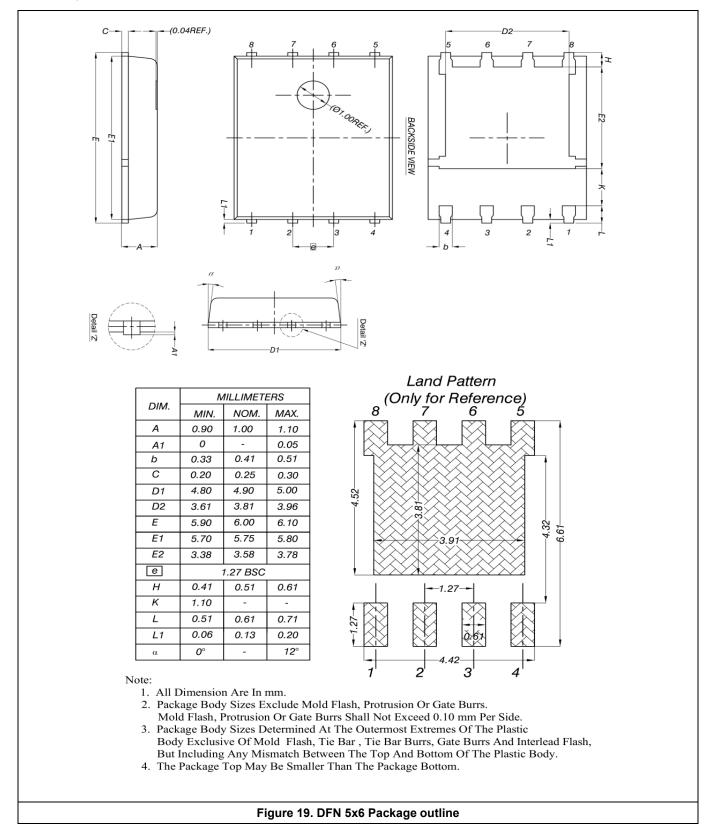


JUNSHINE





Package outline





Disclaimer:

JUNSHINE does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

JUNSHINE reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

JUNSHINE makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, JUNSHINE disclaims (1) any and all liability arising out of the application or use of any product, (2) any and all liability, including without limitation special, consequential or incidental damages, and (3) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

JUNSHINE products, except as expressly indicated in writing, are not designed for use in medical, life-saving, or lifesustaining applications, or for any other application in which the failure of the JUNSHINE product could result in personal injury or death. Customers using or selling JUNSHINE products not expressly indicated for use in such applications do so at their own risks.

Resale of JUNSHINE products with statements different from or beyond the parameters stated by JUNSHINE for that product or service voids all express or implied warrantees for the associated JUNSHINE product or service and is unfair and deceptive business practice. JUNSHINE is not responsible or liable for any such statements.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of JUNSHINE. Product names and markings noted herein may be trademarks of their respective owners.

JUNSHINE IS A FULLY OWNED SUBSIDIARY OF Wuxi XICHANWEIXIN Semiconductor Co., Ltd.